Conclusion of Merger Agreement to Establish Renesas Electronics Corporation

December 15, 2009

NEC Electronics Corporation President & CEO
Junshi Yamaguchi

Renesas Technology Corp. Representative Director, President
Yasushi Akao
I. Overview of Merger Agreement

NEC Electronics Corporation President & CEO
Junshi Yamaguchi
Renesas Technology Corp.  

NEC Electronics Corporation  

Renesas Electronics Corporation
Pre/Post-Merger Capital Injection and Ownership Ratio of Renesas Electronics Corporation

**Integration Ratio**

1

1.189

**New shares to be issued upon merger**

(20.5 shares of NEC Electronics common stock will be issued in exchange for every Renesas share)

**Approximately 71.7 billion yen**

Pre-merger Capital Injection by March 2010

**Approximately 55.0 billion yen**

Post-merger Capital Injection (completed)

**Approximately 16.7 billion yen**

Renesas Technology Corp.

**Note:**

“NEC” is NEC Corporation, “Hitachi” is Hitachi, Ltd, “Mitsubishi Electric” is Mitsubishi Electric Corporation
Share Allocation Ratio in accordance with the Merger

NEC Electronics will issue 20.5 shares of its common stock in exchange for every Renesas common share.

<table>
<thead>
<tr>
<th>Description</th>
<th>Number of Shares</th>
</tr>
</thead>
<tbody>
<tr>
<td>Total number of shares issued at NEC Electronics</td>
<td>123,500,000</td>
</tr>
<tr>
<td>Total number of shares to be issued upon merger</td>
<td>146,841,500</td>
</tr>
<tr>
<td>to Hitachi</td>
<td>80,762,825</td>
</tr>
<tr>
<td>to Mitsubishi Electric</td>
<td>66,078,675</td>
</tr>
<tr>
<td>Total number of Renesas shares at the previous day of the effective date of</td>
<td>7,163,000</td>
</tr>
<tr>
<td>the merger</td>
<td></td>
</tr>
<tr>
<td>Share allocation ratio</td>
<td>20.5</td>
</tr>
</tbody>
</table>

A = Total number of shares issued at NEC Electronics
B = A x 1.189 (Integration Ratio)
B x 55% (Ownership Ratio)
B x 45% (Ownership Ratio)
C = Total number of Renesas shares at the previous day of the effective date of the merger

B/C = Share allocation ratio

NEC Electronics will issue 20.5 shares of its common stock in exchange for every Renesas common share.
Outline of the Third-Party Allotment of New Shares after Merger

This capital injection plan (which will be implemented at 917 yen/share) will become effective following the adoption of the resolutions at NEC Electronics’ (the surviving company) Extraordinary General Meeting of Shareholders

<table>
<thead>
<tr>
<th></th>
<th>NEC</th>
<th>Hitachi</th>
<th>Mitsubishi Electric</th>
</tr>
</thead>
<tbody>
<tr>
<td>Total number</td>
<td>61,395,857</td>
<td>46,962,923</td>
<td>38,424,210</td>
</tr>
<tr>
<td>of shares issued</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Total number of shares issued after the Merger (before the Post-merger Capital Injection): 270,341,500 (A)

Total number of shares issued after the Post-merger Capital Injection: 417,124,490 (A) + (B)

Dilution from the third-party allotment of new shares: (B)/(A) : 54.3 %
# Schedule of Business Integration

<table>
<thead>
<tr>
<th>Date</th>
<th>Event</th>
</tr>
</thead>
<tbody>
<tr>
<td>Dec 15</td>
<td>Signing of Merger Agreement (Originally scheduled for mid-January)</td>
</tr>
<tr>
<td></td>
<td>Determination of accounting acquirer and accounting principle</td>
</tr>
<tr>
<td>Early Feb</td>
<td>Calling of Extraordinary General Meeting of Shareholders at both NEC</td>
</tr>
<tr>
<td>(planned)</td>
<td>Electronics and Renesas</td>
</tr>
<tr>
<td>Feb 24</td>
<td>• Extraordinary General meeting of Shareholders at both NEC Electronics and Renesas for approval of merger</td>
</tr>
<tr>
<td>(planned)</td>
<td>• Appoint new executives, resolution of the Post-merger Capital Injection at NEC Electronics’ extraordinary Shareholders’ meeting <em>(Subject to Approval from the Concerned Authorities of Antitrust Law)</em></td>
</tr>
<tr>
<td>Apr 1</td>
<td>Effective Date of Merger</td>
</tr>
<tr>
<td>(planned)</td>
<td>Launch of the Integrated Company</td>
</tr>
</tbody>
</table>
**Administrative Organization of the Integrated Company**

~Members of the Board~

The list below indicates the 11 persons who will be appointed to the Members of the Board of the Integrated Company following the approval from NEC Electronics’ (the surviving company) Extraordinary General meeting of Shareholders.

<table>
<thead>
<tr>
<th>Position</th>
<th>Name</th>
<th>Notes</th>
</tr>
</thead>
<tbody>
<tr>
<td>Representative Director, Chairman</td>
<td>Junshi Yamaguchi</td>
<td>(President &amp; CEO of NEC Electronics*)</td>
</tr>
<tr>
<td>Representative Director, President</td>
<td>Yasushi Akao</td>
<td>(Representative Director, President of Renesas *)</td>
</tr>
<tr>
<td>Member of the Board</td>
<td>Kazuaki Ogura</td>
<td>(General Manager, Merger Preparation Office of Renesas*)</td>
</tr>
<tr>
<td>Member of the Board</td>
<td>Masaki Kato</td>
<td>(Executive Vice President and Member of the Board of NEC Electronics*)</td>
</tr>
<tr>
<td>Member of the Board</td>
<td>Yoichi Yano</td>
<td>(Executive Vice President and Member of the Board of NEC Electronics*)</td>
</tr>
<tr>
<td>Member of the Board</td>
<td>Shozo Iwakuma</td>
<td>(Board Director and General Manager of Human Resources &amp; General Affairs Division of Renesas*)</td>
</tr>
<tr>
<td>Outside Director</td>
<td>Toyoaki Nakamura</td>
<td>(Representative Executive Officer, Senior Vice President and Executive Officer of Hitachi*)</td>
</tr>
<tr>
<td>Outside Director</td>
<td>Nobuhiro Endo</td>
<td>(Senior Vice President and Member of the Board of NEC*)</td>
</tr>
<tr>
<td>Outside Director</td>
<td>Noritomo Hashimoto</td>
<td>(Executive Officer, Director of Mitsubishi Electric, Outside Director of Renesas*)</td>
</tr>
<tr>
<td>Outside Director</td>
<td>Hajime Matsukura</td>
<td>(General Manager, Corporate Strategy and Business Development of NEC and Outside Director of NEC*)</td>
</tr>
<tr>
<td>Outside Director</td>
<td>To be determined</td>
<td>(Plan to appoint an expert director from the high-tech field)</td>
</tr>
</tbody>
</table>

Note: Asterisks (*) indicate position currently held. The Members of the Board who are not currently NEC Electronics’ Members of the Board will officially be appointed following the adoption of the resolutions at the Extraordinary General Meetings of Shareholders to be held on Feb 24, 2010. The Representative Directors will officially be appointed following the adoption of the resolution at the Board of Directors meeting to be held on April 1, 2010.
The list below indicates the 4 persons who will be appointed to the Corporate Auditors of the Integrated Company following the approval from NEC Electronics’ (the surviving company) Extraordinary General meeting of Shareholders.

<table>
<thead>
<tr>
<th>Role</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Corporate Auditor (full-time/inside)</td>
<td>Keiji Suzuki</td>
<td>(Corporate Auditor of NEC Electronics*)</td>
</tr>
<tr>
<td>Corporate Auditor (full-time/inside)</td>
<td>Hiroki Kawamura</td>
<td>(Corporate Auditor of NEC Electronics*)</td>
</tr>
<tr>
<td>Corporate Auditor (part-time/outside)</td>
<td>Yasuyuki Shibata</td>
<td>(Corporate Auditor of NEC Electronics*)</td>
</tr>
<tr>
<td>New Corporate Auditor</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Corporate Auditor (full-time/inside)</td>
<td>Junichiro Nishi</td>
<td>(Board Director, Executive General Manager of Business Support Unit of Renesas Design Corp. and Executive Manager of Finance &amp; Accounting Controls Div. of Renesas*)</td>
</tr>
</tbody>
</table>

Note: Asterisks (*) indicate position currently held.
II. Business Management Policy of the Integrated Company

Renesas Technology Corp. Representative Director, President Yasushi Akao
Business Management Policy and Targets

**Business Management Policy**

- Rapidly promote operational efficiencies through realization of synergies from the business integration
- Expand foreign business with streamlined resources
- Aim to expand sales and profits by growing global businesses

**Business Targets**

- Start operation with healthy balance sheet
- Achieve operating profit within the first fiscal year
- Aim to attain net profit in the second fiscal year through successful implementations of structural reforms at an early stage of the merger
- Target two-digit operating profit ratio (compared with net sales) in the medium-term
Balance Sheet of the Integrated Company

**Renesas Technology**  
(Japan-GAAP, as of Sep. 30, 2009)

<table>
<thead>
<tr>
<th>Cash and cash equivalents</th>
<th>106.0</th>
</tr>
</thead>
<tbody>
<tr>
<td>Other current assets</td>
<td>274.7</td>
</tr>
<tr>
<td>Fixed assets</td>
<td>303.6</td>
</tr>
<tr>
<td>Current liabilities</td>
<td>373.5</td>
</tr>
<tr>
<td>Accrued pension and severance costs</td>
<td>111.6</td>
</tr>
<tr>
<td>Shareholders’ equity (including minority shareholders' equity)</td>
<td>171.6</td>
</tr>
</tbody>
</table>

**NEC Electronics**  
(US-GAAP, as of Sep. 30, 2009)

<table>
<thead>
<tr>
<th>Cash and cash equivalents</th>
<th>89.5</th>
</tr>
</thead>
<tbody>
<tr>
<td>Other current assets</td>
<td>128.6</td>
</tr>
<tr>
<td>Fixed assets</td>
<td>247.4</td>
</tr>
<tr>
<td>Current liabilities</td>
<td>145.3</td>
</tr>
<tr>
<td>Fixed liabilities (excluding accrued pension and severance costs)</td>
<td>147.1</td>
</tr>
<tr>
<td>Accrued pension and severance costs</td>
<td>80.8</td>
</tr>
<tr>
<td>Shareholders’ equity (including minority shareholders' equity)</td>
<td>92.3</td>
</tr>
</tbody>
</table>

**Variable Factors by the effective date of Merger**

- Additional capital injection as much as 16.7 billion yen to Renesas (in FY10/3)
- Financial outcome of the two companies in 2H FY10/3
- An alignment of GAAP and accounting policy among the two companies
- The post-merger capital injection as much as approx. 134.6 billion yen on the effective date of the merger

The integrated company will start with healthy B/S
Sales by Platform at the Integrated Company

- Provide 3 product groups, MCU, SoC and discrete semiconductor (analog & power device) as the key businesses of the Integrated company.
- Promote steady growth in sales by providing MCUs, SoCs and discrete semiconductors as kit solutions.

*Note: Amounts shown above represent the sum of each sales at NEC Electronics and Renesas.

FY09/3 *Note FY10/3 *Note FY11/3 Projection

Renesas Electronics Corporation
Provide Three Enhanced Product Gr. for W/W Customers

Increase W/W Customer Satisfaction

Provide System Solutions with MCU as the Core Product

MCU
As the World’s No.1

SoC
Competitive in Global Market

Discrete Semiconductors (Analog & Power Device)
Broad Product Portfolio
Enhancement Policy for MCU Business

**Enhancement of Support**
Rapidly streamline global sales network and service network

**Provide Total Solutions**
Establish organizations based on marketing

**Speed up Product Development**
Consolidation of design platforms

**Enhance leading-edge technologies**
Hi-k, super low power, multi-core, high-speed flash memory, etc

**Rapidly unify both companies’ strength on MCU to further expand customer base and business growth**

**Safety & Security**
Maintain product lineups to value customers’ assets

**High-Quality at Low Cost**
Streamline manufacturing lines, Utilize fab networks
Strong Product Lineups through Synergy with Core MCU

SoC
Enhance sales and efficiency through convergence of marketing and technology development on SoC and high-end MCU

Provide rich lineup of kit solutions between SoC and Discrete semiconductors

Discrete Semiconductor (Analog & Power Device)
Expand discrete semiconductors to sales channels widened by MCU and MCU-embedded devices

Utilize the Synergy

World’s top MCU of Renesas Electronics

Upgrade presence and corporate image as the No.1 company

Utilize broad channels to access customers W/W

Sustain Profitability and Stability on MCU business with long-lasting products
Attain Growth in the Global Market

- Expand foreign sales in green applications
  - **Smart Grid:** MCUs for electricity meters, RF semiconductors
  - **Low-power home electronics:** MCUs for inverter control, LED driver
  - **Green cars:** MCUs for motor/power supply control, Optical devices

- Enhance marketing and product development for emerging markets
  - Strengthen local marketing and product planning for the customers around the world
  - Expand low-cost products for BRICs, etc

(FY09/3 Actual *Note)

*Sales for semiconductor devices

*Note: Amounts shown above represent the sum of each sales at NEC Electronics and Renesas.*
Realization of New Policies within the first 100 days

- Paramount project to be completed in the first 100 days
- Assign task force to screen out businesses in focused areas
- Aggressively implement structural reforms by the top-down management

New policies:

- Improve development efficiency by standardizing design/development platforms, and concentrate resources on focused applications and products
- Enhance fab utilization rates and suppress CAPEX by efficient usage of both companies’ production lines
- Reduce cost by efficient procurement and increased outsourcing
- Streamline sales operations and strengthen marketing and customer support locally to expand foreign sales
- Cut cost through consolidation of infrastructures including logistics and IT systems

Reduce fixed cost

Expand business in emerging markets
Aims of the New Company

- Create Globally Competitive Products
- Attain Growth in the Global Market
- Continuously Promote Structural Reforms

Enhance Corporate Value Through Customer Value Creation
Cautionary Statements

The statements in this presentation with respect to the plans, strategies and forecasts of NEC Electronics and Renesas Technology (collectively “we”) are forward-looking statements involving risks and uncertainties. We caution you in advance that actual results could differ materially from such forward-looking statements due to several factors. The important factors that could cause actual results to differ materially from such statements include, but are not limited to: general economic conditions in our markets, which are primarily Japan, North America, Asia and Europe; demand for, and competitive pricing pressure on, our products and services in the marketplace; our ability to continue to win acceptance of its products and services in these highly competitive markets; and movements in currency exchange rates, particularly the rate between the yen and the U.S. dollar. Among other factors, a worsening of the world economy; a worsening of financial conditions in the world markets, and a deterioration in the domestic and overseas stock markets, would cause actual results to differ from the projected results forecast.